Home > Products > By Type > Parallel (Stacking) Configuration > Product Feature Selector > Product Details

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1-120529-1 Product Details

1-120529-1

Active

Connectors

5 of 6 EU RoHS/ELV Compliant (Find RoHS Compliant Alternates/Statement of Compliance)

.4mm, .5mm, .6mm, .8mm, 1mm, Fine Pitch, Surface Mount, Stacking Bd-to-Bd

Product Highlights:

- Receptacle
- Family Name = Free Height
- 1.00 mm Centerline
- Number of Positions = 64
- In-Line Contact Layout

View all Features | Find Similar

Live Product Chat US

Quick Links

Check Pricing & Availability Search for Tooling View Mating Products (12) <u>Product Feature</u> <u>Selector</u> Contact Us About This Product

Documentation & Additional Information

Product Drawings:

RECEPTACLE ASSEMBLY, W/ COVER, 1.0mm FH(IEEE1386)
CON... (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

· None Available

Application Specifications:

None Available

Instruction Sheets:

None Available

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version H)
- 3D Model (IGES, Version H)
- 3D Model (STEP, Version H)

Additional Information:

• Product Line Information

Additional Product Images:

Product Photo

Related Products:

- Tooling
- Mating Products (12)

List all Documents

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- <u>Gender</u> = Receptacle
- Number of Positions = 64
- PCB Mount Angle = Vertical
- Keyed = No
- Comment = IEEE 1386 Mezzanine Connector.

Termination Related Features:

• Solder Tail Contact Plating = Tin-Lead over Nickel

Body Related Features:

- Centerline (mm [in]) = 1.00 [0.039]
- Board-to-Board Stack Height (mm [in]) = 11.00 [0.433], 12.00 [0.472]
- Grounding Plate = Without
- <u>Grounding Contact</u> = Without
- Locating Posts = Without
- Vacuum Cover = With
- Number of Rows = Dual

Contact Related Features:

- Family Name = Free Height
- <u>Contact Layout</u> = In-Line
- Contact Material = Copper Alloy
- Contact Mating Area Plating = Gold (50)

Housing Related Features:

- Housing Color = Black
- Housing Material = Thermoplastic High Temperature
- Housing Flammability Rating = UL 94V-0
- Housing Material Temperature = High

- Compliant
 - <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C, Wave solder capable to 260° C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 260°C, Pin-in-Paste capable to 245°C, Pinin-Paste capable to 260°C

Packaging Related Features:

Packaging Method = Tape & Reel

Other:

Brand = AMP

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